## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Che-Tung WU	10/04/2007
Chih-Ho HSU	10/04/2007

### **RECEIVING PARTY DATA**

Name:	Ichia Technologies, Inc.	
Street Address:	268,Hwa-Ya 2nd Road, Hwa-Ya Tech. Park	
City:	Gueishan, Taoyuan	
State/Country:	TAIWAN	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12014857

#### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	Chun-Ming Shih

Total Attachments: 1 source=ass670#page1.tif

\$40.00

PATENT REEL: 020369 FRAME: 0994

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# ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS Che-Tung WU, C	hih-Ho HSU			
		ented a certain improvement relating to		
METAL KEYPAD PANEL STRUCT	URE WITH MICROPO	DRE ARRAY		
[x] the inventor(s) declaration for said application being executed concurrently with the execution of this instrument; said application to be filed in the United States Patent and Trademark Office; [] said application having been filed in the United States Patent and Trademark Office on				
(Application Serial No. ) the	e application serial nur	mber of said application when known;		
I I said application having been filed	l under the Patent Coo	peration Treaty on		
, (Serial No	)the United States	s of America being designated.		
AND WHEREAS _lchia Techn				
who's address is <b>268,Hwa-Ya 2nd</b>	i Road, Hwa-Ya Tech	. Park, Gueishan, Taoyuan, Taiwan, R.O.C.		
said application, including any and a any and all patents which may b prolongations thereof;	all divisions and continue granted therefore,	uiring the entire right, title and interest in and to uations thereof, and in and to said invention and including any and all renewals, reissues and		
NOW THIS WITNESSETH, that valuable consideration paid by said a said assignor hereby assigns, sells	assignee to said assigr and transfers to said	tion of One Dollar (\$1.00), and other good and nor, the receipt of which is hereby acknowledged, assignee, and said assignee's successors and and to said application, including any and all		
divisions and continuations thereof, granted therefore, including any and	and in and to said in all renewals, reissue	evention and any and all patents which may be s and prolongations thereof; said assignee, and exercise and enjoy the said application, including		
any and all divisions and continuation	ons thereof, and the sa	aid invention and any and all patents which may		
be granted therefore, including any a	and all renewals, reissi	ues and prolongations thereof, with all the rights, or appertaining thereto, for and during the term		
or terms of any and all such par prolongations thereof, for the use	tents when granted, and benefit of said a	including any and all renewals, reissues and assignee, and said assignee's successors and		
the same, if this assignment had not		assignor might or could have held and enjoyed		
AND said assignor hereby agre successors or assigns, any and a	es to perform, upon that acts relating to the	he request of said assignee, or said assignee's obtaining or to the asserting of said patents,		
including any and all renewals, reiss AND said assignor authorizes a	and requests the Com	missioner of Patents and Trademarks to issue		
Letters Patent on said application, at to said assignee, and said assignee'	nd on any and all divisi	ions and continuations thereof,		
	•			
Name of sole or first inventor	ng Wu Signature	October 04, 2007  Date		
Traine of colo of meeting enter	g			
Chib-Ho HSU (Mih	- Mo HLM	October 04, 2007		
Chih-Ho HSU  Name of second inventor, if any	Signature	Date		
Name of third inventor, if any	Signature	Date		
•				
Name of fourth inventor, if any	Signature	Date		
Name of fifth inventor, if any	Signature	Date		

**RECORDED: 01/16/2008** 

PATENT REEL: 020369 FRAME: 0995